



**FUSION
FOR
ENERGY**

Design challenges and strategies for the design of a rad-hard multiplexer and camera for ITER remote handling applications

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Bringing
the power
of the sun
to earth

Remote handling systems and their radiation environment

MARCO Multiplexer

Camera

Conclusion

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The Remote Handing (RH) will be exposed to high radiation environment.
Target 150Gy/hr and **1MGy (TID)**

Cubicles containing control electronics are placed in radiation free areas located at long distances (150m)

Limited space for cable umbilicals between RH devices and cubicles, and maintenance-free equipment during 6-months RH operations campaign, lead to the need of radiation hard electronics for:

- miniaturized **cameras** for surveillance of RH operations or perform inspections
- **multiplexing systems** located on board of the RH equipment to reduce substantially the number of cables

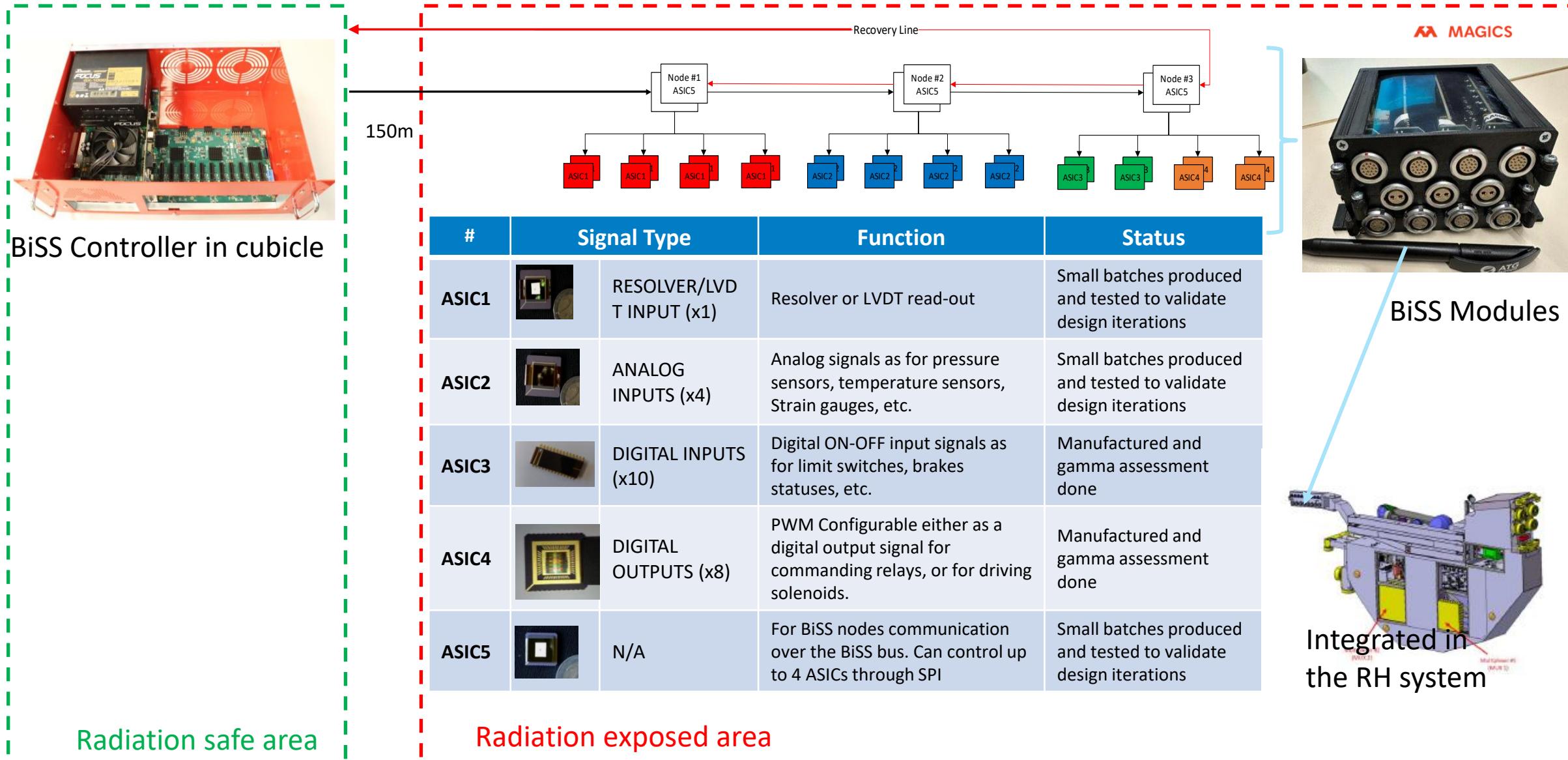
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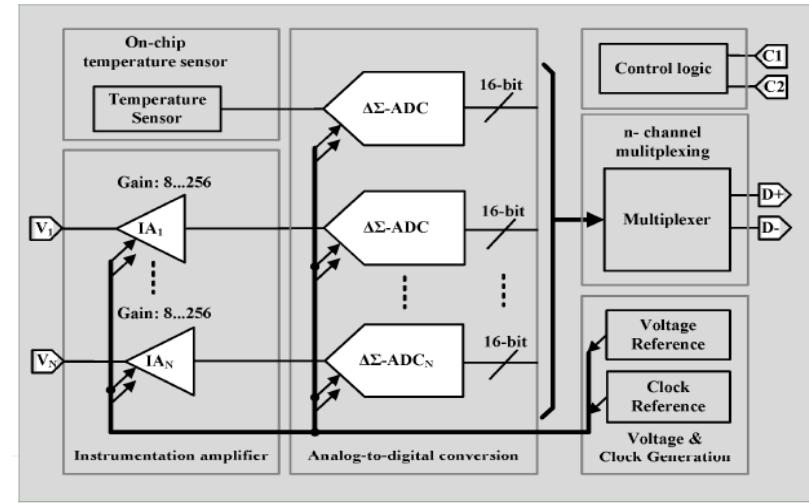
Conclusion

Multiplexer



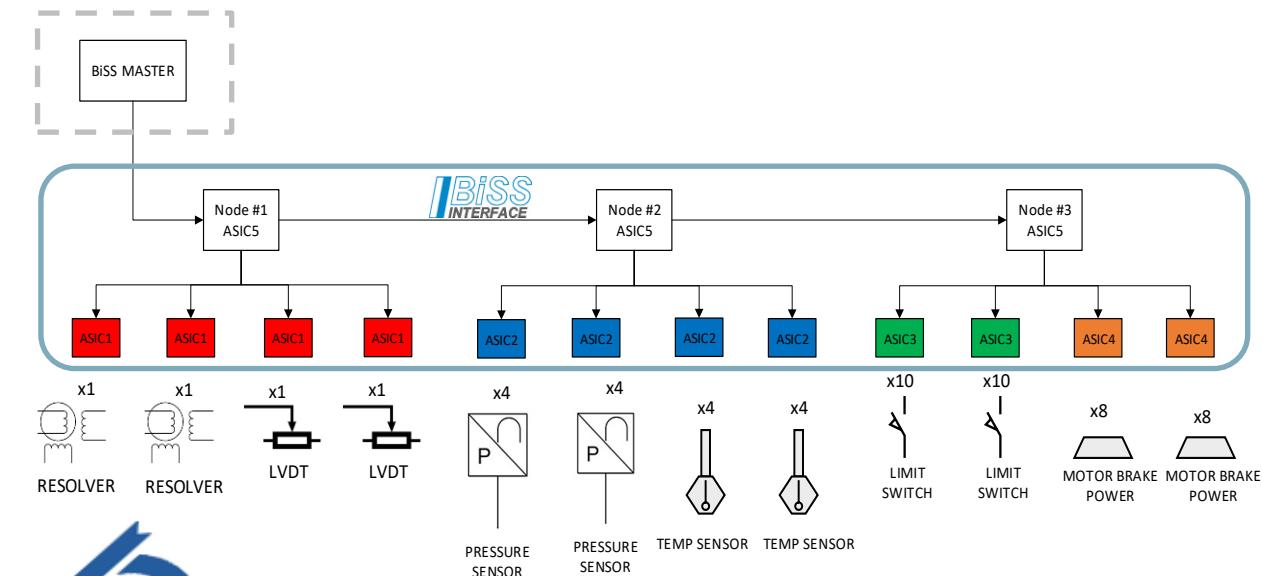
Multiplexer development – staged approach

1st iteration, single chip that amplifies, digitizes and multiplexes sensor signals, validating main building blocks

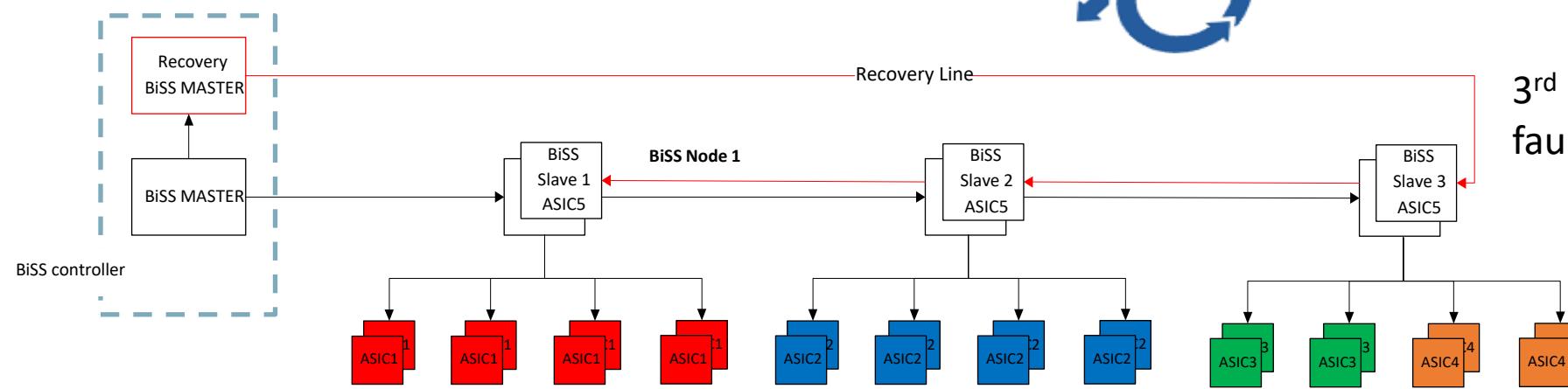


A MGy Radiation-Hardened Sensor Instrumentation SoC in a Commercial CMOS Technology- Y. Cao- NSREC 2014 Poster

2nd iteration, 5 chip typologies and communication BiSS protocol



3rd iteration, introduction of ASIC fault tolerance and recoverability.

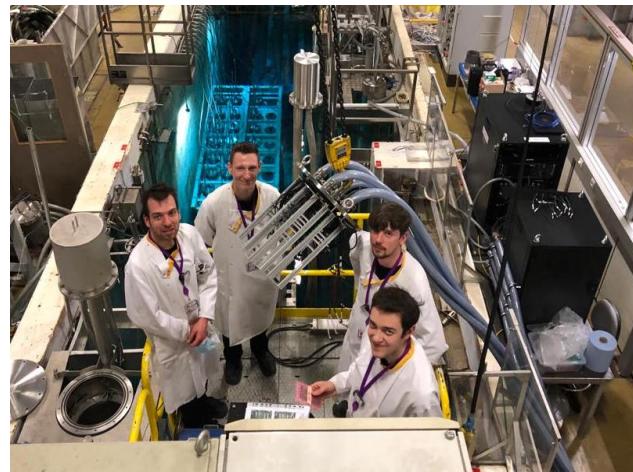


Design iteration:
 -IC design
 -Manuf & testing
 -Irradiations
 -Bugs resolution

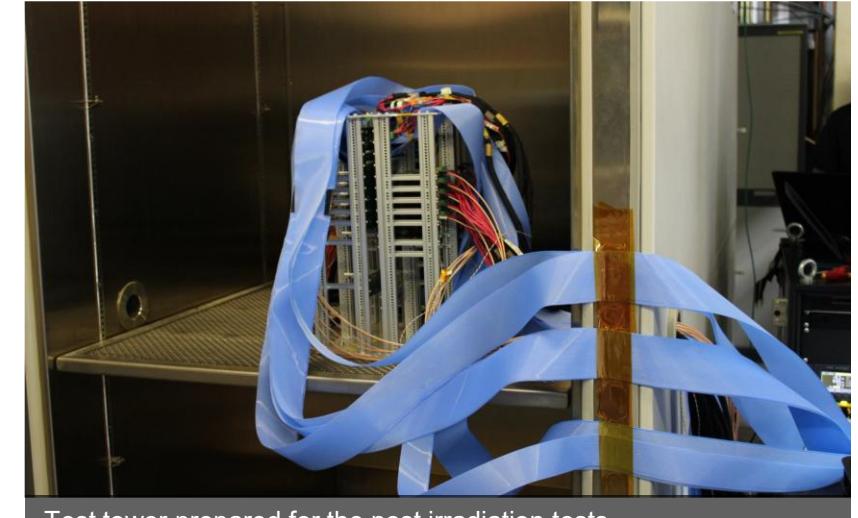
Multiplexer development – Some tests performed



Test tower containing test samples being characterized at different T and V levels before irradiation experiment.



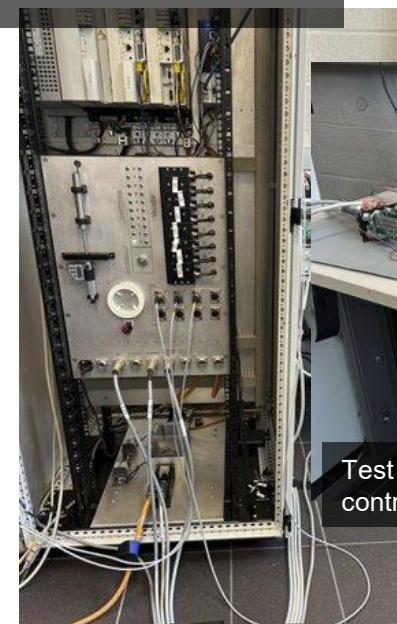
Test tower containing test samples being characterized at different T and V levels before irradiation experiment.



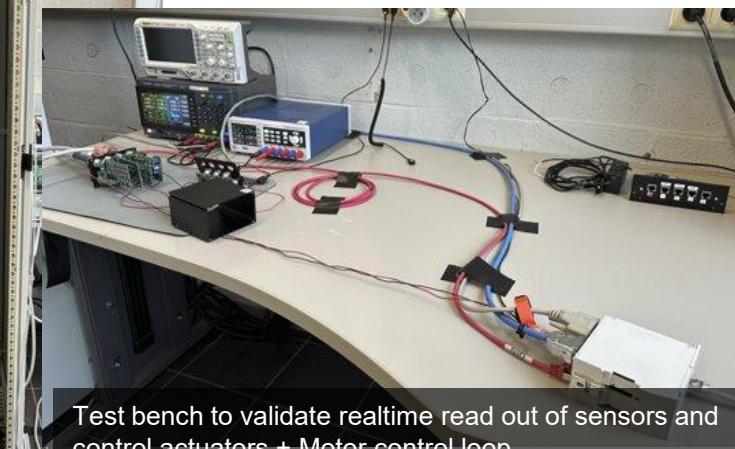
Test tower prepared for the post irradiation tests



Test of 16 redundant ASIC5 connected in a daisy chain.



Test bench to validate realtime read out of sensors and control actuators + Motor control loop.



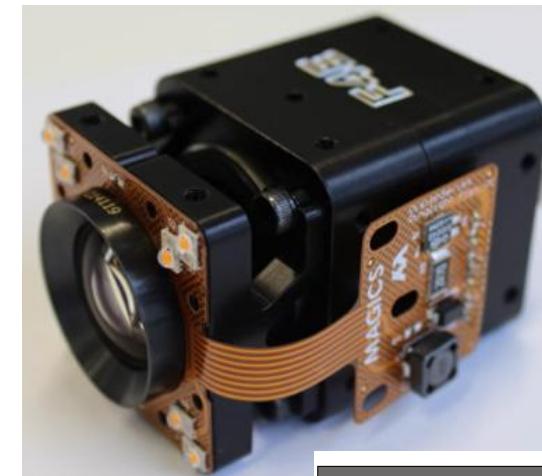
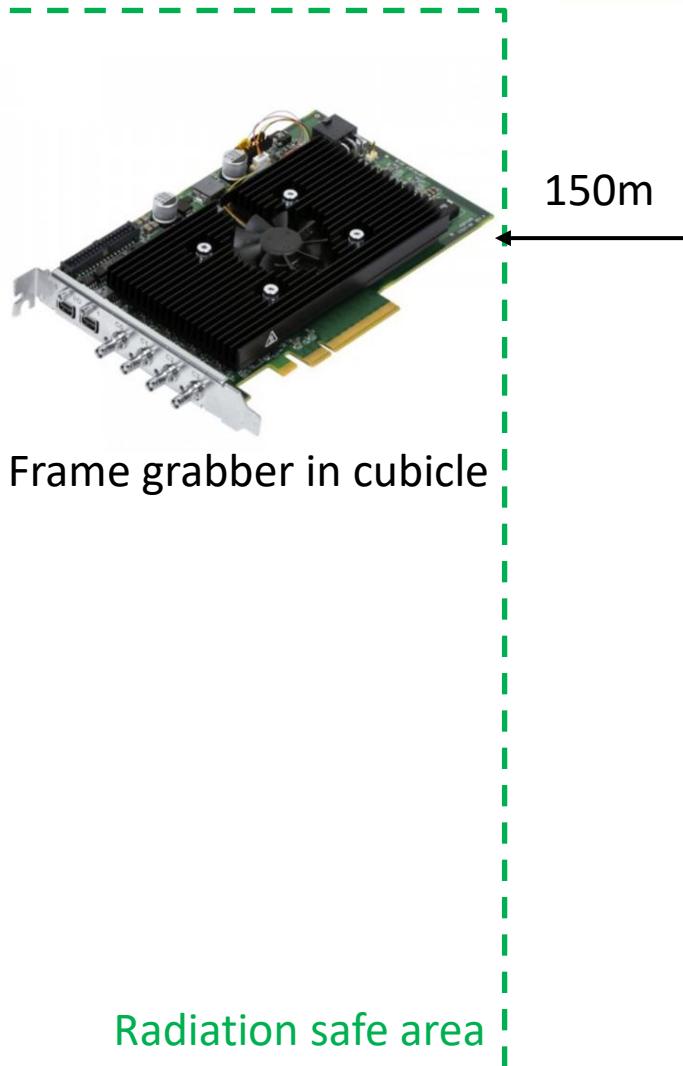
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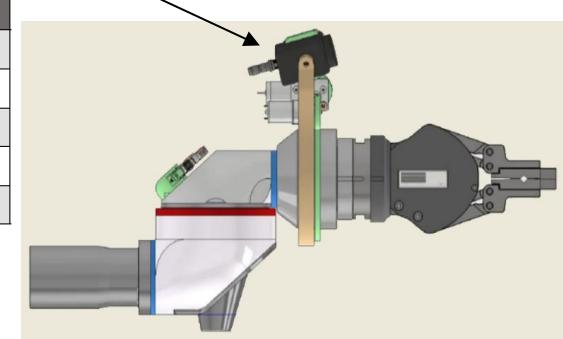
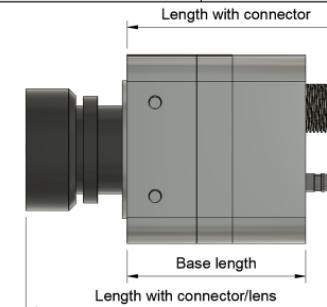
Rad Hard camera



The F4E camera is small-size, black&white or colour, CMOS based, radition tolerant up to 1MGy, and follows the GenICam and CoaXPress standards.

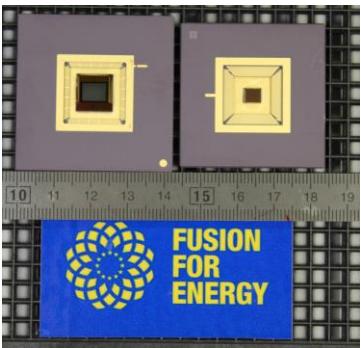
The F4E camera basic configuration delivers VGA video streams at 25 frames/second through a 1.25 Gbits/s CoaXPress 2.0 interface.

Parameter	With LEDs Power PCB [mm]	Without LEDs Power PCB [mm]
Width	40	40
Height	40	40
Base length	37,1	29,5
Length with connector	46,9	39,2
Length with connector/lens	68,5	60,8

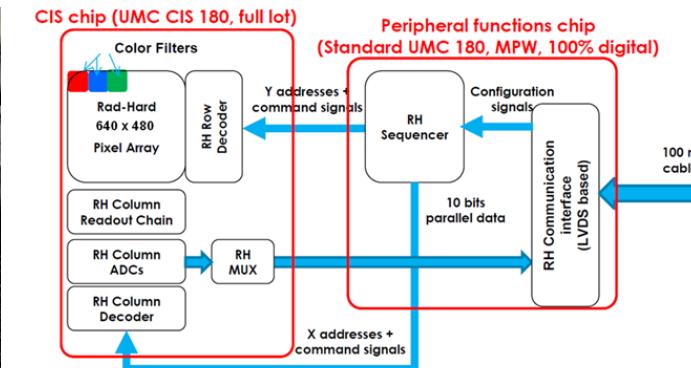
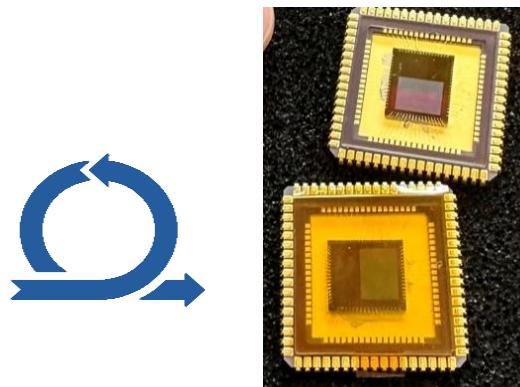


Integrated in
the RH system

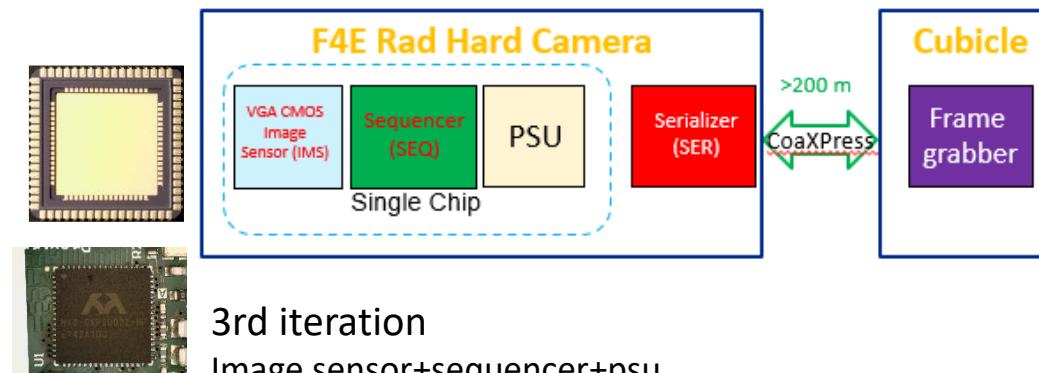
Rad- Hard camera – staged approach



256 x 256 pixel evaluation image sensor
10bit ADC



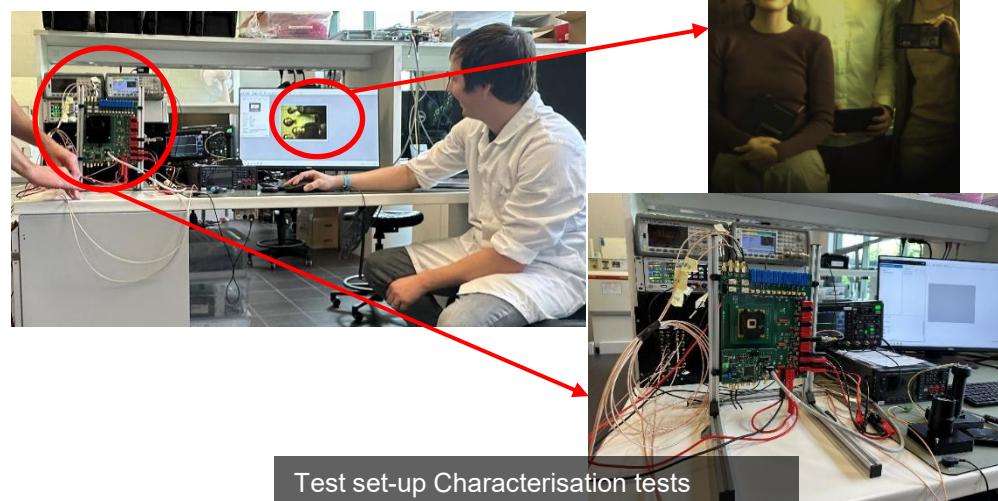
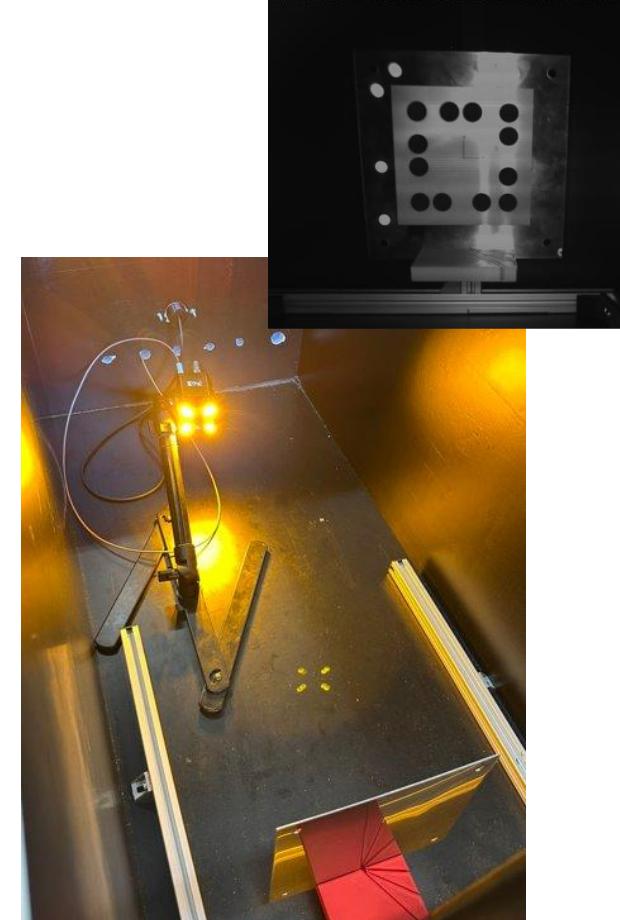
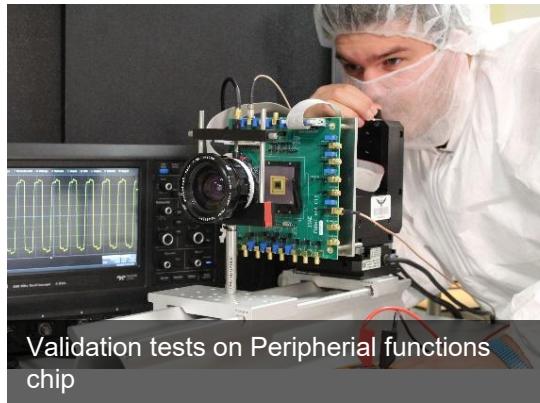
2nd iteration
VGA pixel array + readout blocks
Sequencer (communication chip)



3rd iteration
Image sensor+sequencer+psu
Serialiser (coaxpress)

Design iteration:
-IC design
-Manuf & testing
-Irradiations
-Bugs resolution

Rad-Hard camera development – Staged approach



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Multiplexer and Image sensor developments have been successfully designed and validated and irradiated up to 1MGy (TID) with no degradation in performance observed

To perform these developments:

- Collaboration with experienced industrial partners from Magics Technologies, ISAE-Supaero University of Toulouse, Veolia Nuclear Solutions, Ansaldo Nucleare, SCK-CEN...
- Followed incremental steps in complexity, validated through simulations and tests
- No dedicated standards for such high radiation environments, the ESCC 22900 standard for space applications was used as a reference.

Next steps:

- Full wafer manuf of the remaining chips
- Finalisation BiSS controller
- Radiation assessments
- Integration into RH systems & technologies



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